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ON Semiconductor NSS20600CF8T1G

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Distributor of ON Semiconductor: Excellent Integrated System Limited Datasheet of NSS20600CF8T1G - TRANS PNP 20V 6A 8-CHIPFET Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NSS20600CF8T1G 20 V, 7.0 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e^2 PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb-Free Device

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Rating	Symbol	Max	Unit	
Collector-Emitter Voltage	V _{CEO}	-20	Vdc	
Collector-Base Voltage	V _{CBO}	-20	Vdc	
Emitter-Base Voltage	V _{EBO}	-7.0	Vdc	
Collector Current – Continuous	Ι _C	-6.0	Adc	
Collector Current – Peak	I _{CM}	-7.0	А	
Electrostatic Discharge	ESD		BM Class 3B MM Class C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Characteristic	Symbol	wax	Unit
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 1)	830 6.7	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 1)	150	°C/W
Total Device Dissipation, T _A = 25°C Derate above 25°C	P _D (Note 2)	1.4 11.1	W mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 2)	90	°C/W
Thermal Resistance, Junction-to-Lead #1	$R_{\theta JL}$ (Note 2)	15	°C/W
Total Device Dissipation (Single Pulse < 10 sec)	P _{Dsingle} (Notes 2 & 3)	2.75	W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 @ 100 mm², 1 oz copper traces.

2. FR-4 @ 500 mm², 1 oz copper traces.

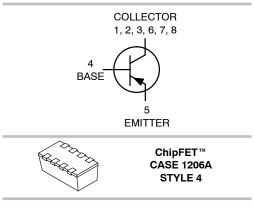
3. Thermal response.



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$\begin{array}{l} -20 \text{ VOLTS, 7.0 AMPS} \\ \text{PNP LOW } V_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \text{EQUIVALENT } R_{\text{DS(on)}} \text{ 50 } \text{m}\Omega \end{array}$



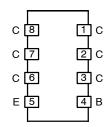
MARKING DIAGRAM



VC = Specific Device Code

- M = Date Code
- = Pb–Free Package

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping [†]	
NSS20600CF8T1G	ChipFET (Pb–Free)	3000/ Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



NSS20600CF8T1G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

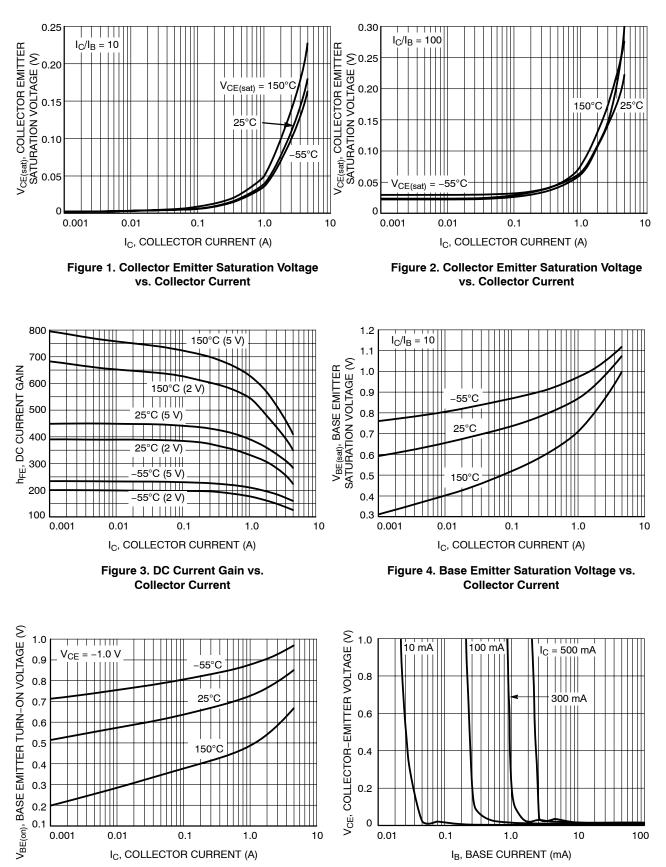
Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS				•	
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	-20	_	-	Vdc
Collector – Base Breakdown Voltage $(I_C = -0.1 \text{ mAdc}, I_E = 0)$	V _{(BR)CBO}	-20	-	-	Vdc
Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$	V _{(BR)EBO}	-7.0	-	-	Vdc
Collector Cutoff Current ($V_{CB} = -20 \text{ Vdc}, I_E = 0$)	I _{CBO}	-	_	-0.1	μAdc
Emitter Cutoff Current (V _{EB} = -7.0 Vdc)	I _{EBO}	-	_	-0.1	μAdc
ON CHARACTERISTICS				•	
DC Current Gain (Note 4) ($I_C = -10 \text{ mA}, I_C = -2.0 \text{ V}$) ($I_C = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -3.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	h _{FE}	250 250 220 200 180	_ 300 _	- - - - -	
Collector – Emitter Saturation Voltage (Note 4) ($I_{C} = -0.1 A$, $I_{B} = -0.010 A$) (Note 5) ($I_{C} = -1.0 A$, $I_{B} = -0.100 A$) ($I_{C} = -1.0 A$, $I_{B} = -0.010 A$) ($I_{C} = -2.0 A$, $I_{B} = -0.020 A$) ($I_{C} = -3.0 A$, $I_{B} = -0.030 A$) ($I_{C} = -4.0 A$, $I_{B} = -0.400 A$)	V _{CE(sat)}	- - - - -	-0.007 -0.050 -0.065 -0.090 -0.140 -0.160	-0.010 -0.060 -0.080 -0.130 -0.180 -0.200	V
Base – Emitter Saturation Voltage (Note 4) ($I_c = -1.0 \text{ A}, I_B = -0.01 \text{ A}$)	V _{BE(sat)}	-	_	-0.90	V
Base – Emitter Turn–on Voltage (Note 4) $(I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V})$	V _{BE(on)}	-	_	-0.90	V
Cutoff Frequency (I _C = -100 mA, V _{CE} = -5.0 V, f = 100 MHz)	f _T	100	_	-	MHz
Input Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz)	Cibo	-	-	700	pF
Output Capacitance (V_{CB} = -3.0 V, f = 1.0 MHz)	Cobo	-	-	280	pF
SWITCHING CHARACTERISTICS				•	
Delay (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _d	-	-	120	ns
Rise (V_{CC} = -15 V, I_{C} = 750 mA, I_{B1} = 15 mA)	tr	-	-	250	ns
Storage (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _s	-	-	400	ns
Fall (V _{CC} = –15 V, I _C = 750 mA, I _{B1} = 15 mA)	t _f	-	-	250	ns

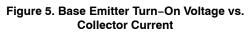
Pulsed Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%.
Guaranteed by design but not tested.

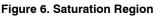


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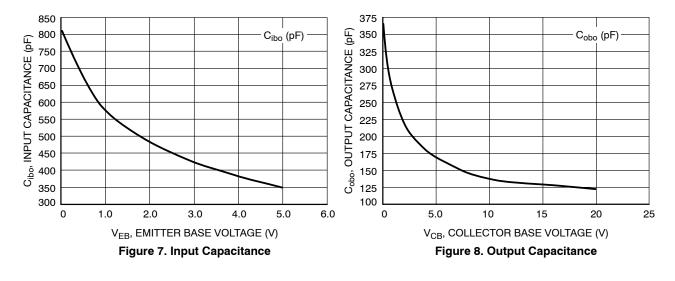


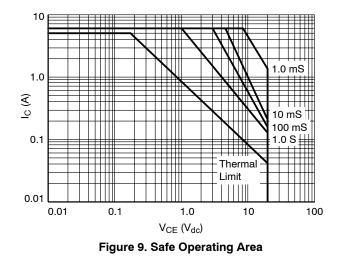




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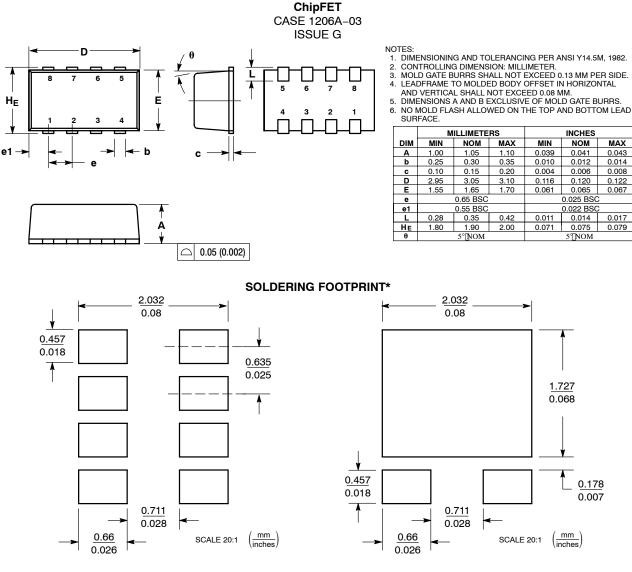






NSS20600CF8T1G

PACKAGE DIMENSIONS



Basic

Style 4

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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NSS20600CF8/D

INCHES

NOM

0.041

0.012

0.006

0.120

).025 BS

0.022 BS

5TNOM

0.178

0.007

mm

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MAX

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